

Schottky Barrier Diode, 20 V NSR05F20NXT5G

These Schottky barrier diodes are optimized for low forward voltage drop and low leakage current and are offered in a Chip Scale Package (CSP) to reduce board space. The low thermal resistance enables designers to meet the challenging task of achieving higher efficiency and meeting reduced space requirements.

Features

- Low Forward Voltage Drop 390 mV @ 500 mA
- Low Reverse Current 15 μA @ 10 V VR
- 500 mA of Continuous Forward Current
- ESD Rating Human Body Model: Class 3B
 - Machine Model: Class C
- High Switching Speed
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- LCD and Keypad Backlighting
- Camera Photo Flash
- Buck and Boost dc–dc Converters
- Reverse Voltage and Current Protection
- Clamping & Protection

Markets

- Mobile Handsets
- MP3 Players
- Digital Camera and Camcorders
- Notebook PCs & PDAs
- GPS

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	20	V
Forward Current (DC)	ΙF	500	mA
Forward Surge Current (60 Hz @ 1 cycle)	I _{FSM}	10	Α
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle = 66%)	I _{FRM}	4.0	А
ESD Rating: Human Body Model Machine Model	ESD	> 8 > 400	kV V

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

20 V SCHOTTKY BARRIER DIODE





DSN2 (0402) CASE 152AC





05F20 = Specific Device Code

YYY = Year Code

ORDERING INFORMATION

Device	Package	Shipping [†]
NSR05F20NXT5G	DSN2 (Pb-Free)	5000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR05F20NXT5G

THERMAL CHARACTERISTICS

Characteristic	Symbol	Min	Тур	Max	Unit
Thermal Resistance Junction-to-Ambient (Note 1) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			240 521	°C/W mW
Thermal Resistance Junction-to-Ambient (Note 2) Total Power Dissipation @ T _A = 25°C	R _{θJA} P _D			94 1.3	°C/W W
Storage Temperature Range	T _{stg}			-40 to +125	°C
Junction Temperature	TJ			+150	°C

- 1. Mounted onto a 4 in square FR-4 board 50 mm sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.
- 2. Mounted onto a 4 in square FR-4 board 1 in sq. 1 oz. Cu 0.06" thick single sided. Operating to steady state.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage (V _R = 10 V) (V _R = 20 V)	I _R			15 75	μΑ
Forward Voltage (I _F = 100 mA) (I _F = 500 mA)	V _F		0.330 0.390	0.345 0.430	V

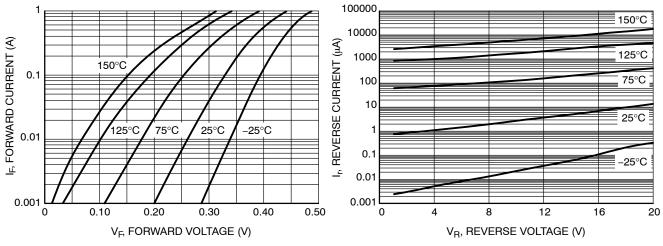


Figure 1. Forward Voltage

Figure 2. Leakage Current

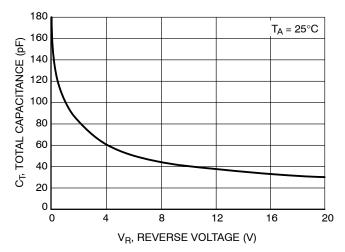


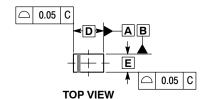
Figure 3. Total Capacitance

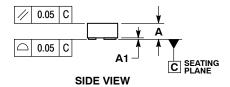


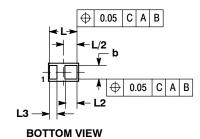


DSN2, 1.0x0.6, 0.575P, (0402) CASE 152AC ISSUE D

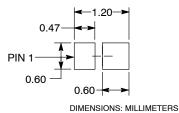
DATE 27 APR 2017







RECOMMENDED SOLDER FOOTPRINT*



See Application Note AND8464/D for more mounting details

NOTES:

- DIMENSIONING AND TOLERANCING PER
 ASME VIA EM 1004
- ASME Y14.5M, 1994.
 2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS			
DIM	MIN	MAX		
Α	0.25	0.31		
A1		0.05		
b	0.45	0.55		
D	1.00 BSC			
Е	0.60 BSC			
Ĺ	0.85	0.95		
L2	0.35	0.45		
L3	0.20	0.30		

GENERIC MARKING DIAGRAM1*

GENERIC MARKING DIAGRAM2*

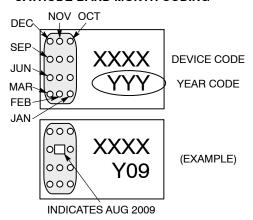




XXXX = Specific Device Code YYY = Year Code XX = Specific Device Code
M = Date Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G", may or not be present. Some products may not follow the Generic Marking.

CATHODE BAND MONTH CODING



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^{*}For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, <u>SOLDERRM/D</u>.

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